DISPLAY Elektronik GmbH

DATA SHEET

LCD MODULE

DEM 128064G FGH

Product Specification

Version: 1

13/Jan/2009

GENERAL SPECIFICATION

MODULE NO.:

DEM 128064G FGH

CUSTOMER P/N:

Version No.	Change Description	Date
0	Original Version	12.12.2008
1	Update Item 1 & Item 7	13.01.2009

PREPARED BY: XYP DATE: 13.01.2009

APPROVED BY: MH DATE: 13.01.2009

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1. FUNCTIONS & FEATURES

MODULE NAME	LCD Type				
DEM 128064G FGH	FSTN Reflective Positive Mode				

• Viewing Direction : 6 o'clock

• Driving Scheme : 1/65 Duty, 1/9 Bias,

Power supply : 3.3 Volt (typ.)
 V_{LCD}(V0-Vss) : 10.7 Volt (typ.)

• Display Format : 128 x 64 Dots, COG

• Interface : Parallel & Serial

• LCD Driver : NT7534H (Novatek)

Operating Temperature : -20°C to +70°C
 Storage Temperature : -30°C to +80°C

2. MODULE ARTWORK

• Module Size : 43.24 x 29.14 x 1.95 mm (without FPC)

• Viewing Area : 37.04 x 20.24 mm

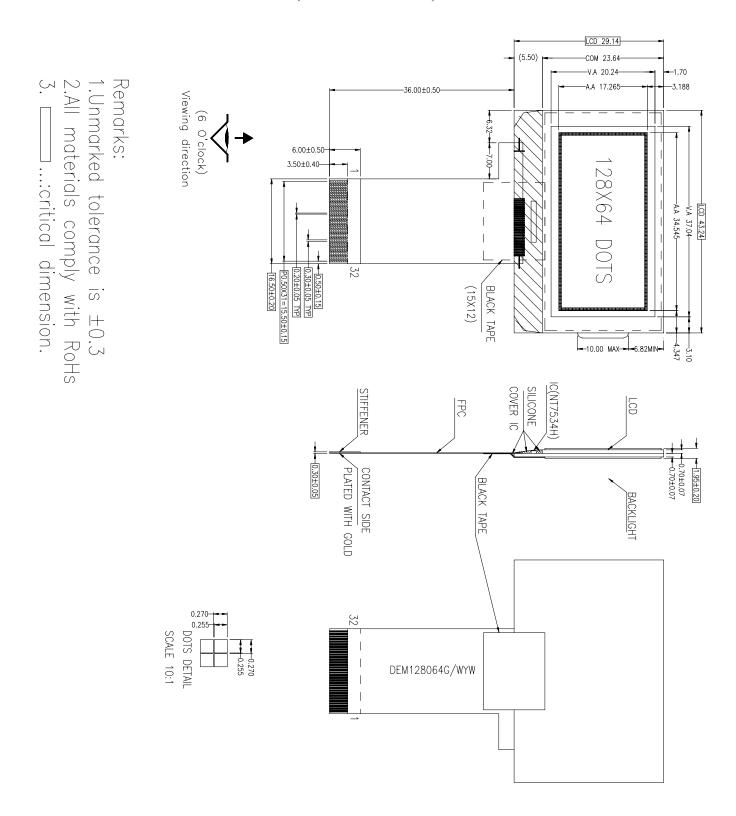
• Active Area : 34.545 x 17.265 mm

• Dot Size : 0.255 x 0.255 mm

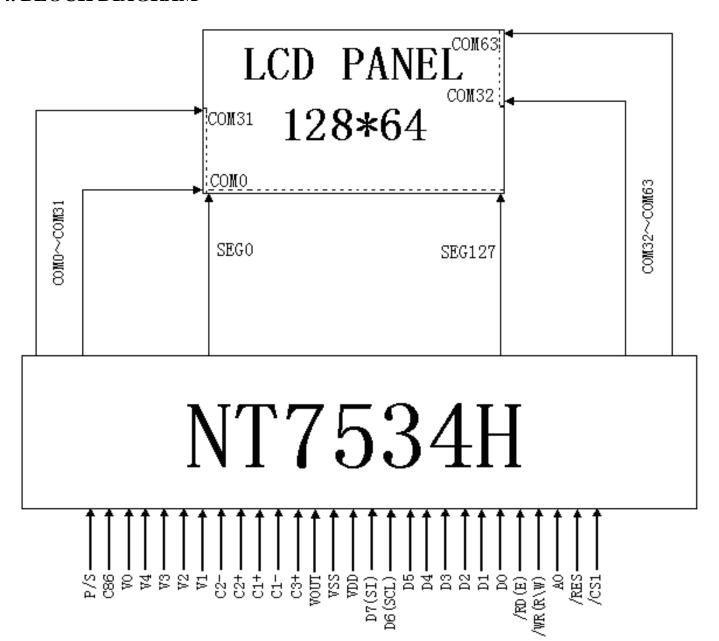
• Dot Pitch : 0.27 x 0.27 mm

• Dot Gap : 0.15mm

3. EXTERNAL DIMENSIONS (unit: mm)



4. BLOCK DIAGRAM



5. PIN ASSIGNMENT.

PIN NO.	Symbol	Description								
1	NC	No connect								
2	NC	No connect								
3	NC	No connect	No connect							
4	NC	No connect								
		P/S = "H": P P/S = "L": S	This is the parallel data input/serial data input switch terminal P/S = "H": Parallel data input P/S = "L": Serial data input The following applies depending on the P/S status:							
						0 101 1	_			
5	P/S		Data/command	Data	Read/Write	Serial Clock	ζ			
		"H"	A0	D0 to D7	/RD,/WR	-				
		"L"	A0	SI(D7)	Write only	SCL(D6)				
			"L", D0 to D5 a							
			W) are fixed to		"L". With se	rial data input,	, RAM display			
			is not supported		1					
	C9.6		IPU interface sw		I					
6	C86		6800 Series MP							
			3080 Series MPI		1	1 .1				
7	V0		supplies voltage	_		•				
,	, ,		mpedance-conv							
			plifier for appli		ges should be					
8	V4		the following re							
			$V2 \ge V3 \ge V4 \ge 1$		4 : 41 C-1	1 :				
			-chip operating							
9	V3	voltages are supplied to V1 to V4 by the on-chip power circuit. Voltage selection is performed by the LCD Bias Set command.								
							V4			
		LCD bia 1/4bias	3/4 V(V2	V3 2/4 V0				
10	V2	1/4bias 1/5bias	4/5 V(4 V0 5 V0	2/4 V0 2/5 V0	1/4 V0 1/5 V0			
		1/3bias 1/6bias	5/6 V0		5 V0	2/5 V0 2/6 V0	1/6 V0			
		1/7bias	6/7 V0		7 V0	2/0 V0 2/7 V0	1/7 V0			
11	V1	1/8bias	7/8 V0		8 V0	2/8 V0	1/8 V0			
11	V 1	1/80ias 1/9bias	8/9 V0		9 V0	2/8 V0 2/9 V0	1/8 V0 1/9 V0			
12	C2						1/9 V U			
12	C2-		pad for internal							
13	C2+	•	pad for interna		•					
14	C1+		pad for interna							
15	C1-		pad for internal							
16	C3+		pad for interna		iage converter	- -				
17	VOUT		ige converter ou	прит						
18	VSS	Ground	• ,							
19	VDD	Power suppl	y input							
20	D7(SI)	-								
21	D6(SCL)	This is an 8-	bit bi-directiona	l data bus tha	it connects to	an 8-bit or 16-	bit standard			
22	D5		us. When the ser							
23	D4		a input terminal							
24	D3		is time, D0 to D							
25	D2		to D7 are set to		-		P 22.000 10			
26	D1		20 27 410 500 10							
27	D0									

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28	/RD(E)	When connected to an 8080 MPU, it is active LOW. This pad is connected to the /RD signal of the 8080MPU, and the NT7534 data bus is in an output status when this signal is "L". When connected to a 6800 Series MPU, this is active HIGH. This is used as an enable clock input of the 6800 series MPU
29	/WD(R/W)	When connected to an 8080 MPU, this is active LOW. This terminal connects to the 8080 MPU /WR signal. The signals on the data bus are latched at the rising edge of the /WR signal. When connected to a 6800 Series MPU, this is the read/write control signal input terminal. When R/W = "H": Read When R/W = "L": Write
30	A0	This is connected to the least significant bit of the normal MPU address bus, and it determines whether the data bits are data or a command. A0 = "H": Indicate that D0 to D7 are display data A0 = "L": Indicates that D0 to D7 are control data
31	/RSE	When /RES is set to "L", the settings are initialized. The reset operation is performed by the /RES signal level
32	/CS1	This is the chip select signal. When /CS1="L" and CS2="H", then the chip select becomes active, and data/command I/O is enabled.

6. ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min.	Max.	Uuit
Power	$V_{ m DD}$	-0.3	+4.0	V
Voltage converter output	Vout,V0	-0.3	+15.0	V
Input voltage	$V_{\rm IN}$	-0.3	V _{DD} +0.3	V
Operating temperature	Topr	-20	+70	°C
Storage temperature	Tstg	-30	+80	°C

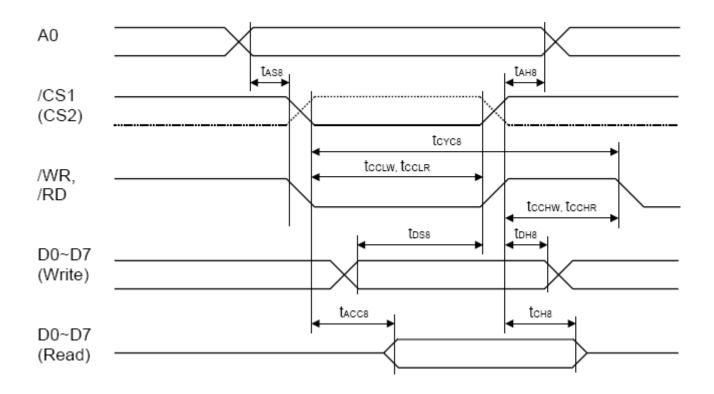
7. ELECTRICAL CHARACTERISTICS

7-1. DC Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Operating Voltage	$ m V_{DD}$	3.0	3.3	3.6	V	
LCD Voltage	V_{LCD}	10.4	10.7	11.0	V	V0-Vss
		-	20	35	uA	V _{DD} =3.3V,V0=10.7V, built-in boosting power supply off, display on, Display data=checker and no access Ta=25°C
I_{DD}	Current consumption	-	90	160	uA	V _{DD} =3.3V,V0=10.7V, 4x built-in boosting power supply, display on, Display data=checker and no access, Temperature radiant is -0.05%/°C, Ta=25°C
		-	150	255	uA	V _{DD} =3.3V, V0=10.7V, 4x built-in boosting power supply, display on, Display data=checker and no access, Temperature gradient is -0.05%/°C, Ta=25°C

7-2. AC Characteristics

System Buses Read/Write Characteristics (for 8080 Series MPU)



Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition	
Таня	Address hold time	0	-	-	ns	A0	
Tas8	Address setup time	0	-	-	ns	AU	
tcyc8	System cycle time	240	1	-	ns		
tccLw	Control low pulse width (write)	90	1	-	ns	/WR	
tcclr	Control low pulse width (read)	120	-	-	ns	/RD	
tсснw	Control high pulse width (write)	100	-	-	ns	/WR	
tccнr	Control high pulse width (read)	60	-	-	ns	/RD	
TDS8	Data setup time	40	-	-	ns	D0~D7	
Трня	Data hold time	10	1	-	ns	ו טי~טו	
tacc8	/RD access time	-	-	140	ns	D0~D7_CL = 100°E	
Тсн8	Output disable time	5	-	50	ns	D0~D7, CL = 100pF	

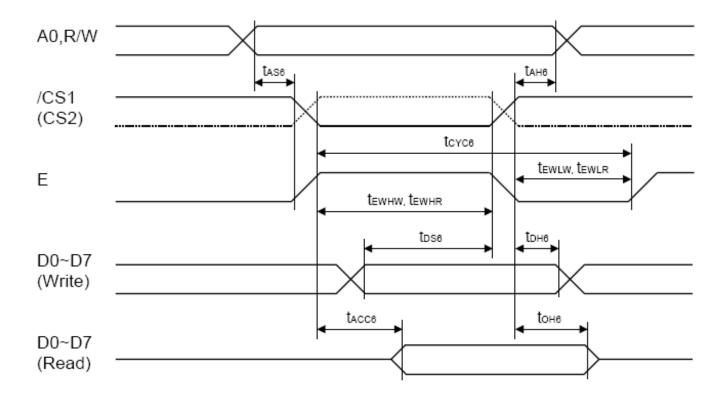
^{*1.} The input signal rise time and fall time (tr, tr) is specified at 15ns or less.

(tr + tr) < (tcycs - tcclw - tcchw) for write, (tr + tr) < (tcycs - tcclr - tcchr) for read.

^{*2.} All timing is specified using 20% and 80% of VDD as the reference.

^{*3.} tccLw and tccLR are specified as the overlap interval when /CS1 is low (CS2 is high) and /WR or /RD is low.

System Buses Read/Write Characteristics (for 6800 Series MPU)



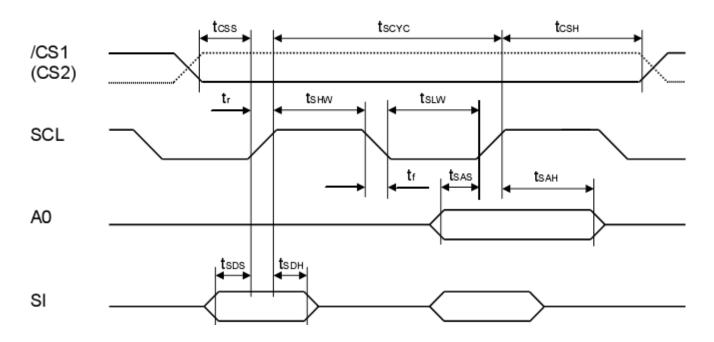
Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
tan6	Address hold time	0	-	-	ns	A0, R/W
tase	Address setup time	0	1	-	ns	A0, R/W
tcyc6	System cycle time	240	1	-	ns	
tewnw	Control high pulse width (write)	90	-	-	ns	Е
tewhr	Control high pulse width (read)	120	-	-	ns	E
tewLw	Control low pulse width (write)	100	-	-	ns	E
tewlr	Control low pulse width (read)	60	-	-	ns	Е
tos6	Data setup time	40	ı	-	ns	D0~D7
tон6	Data hold time	10	ı	-	ns	D0 *D1
tacc6	/RD access time	-	1	140	ns	D0~D7
tон6	Output disable time	5	-	50	ns	CL = 100pF

^{*1.} The input signal rise time and fall time (t_r, t_f) is specified at 15ns or less. (t_r + t_f) < (tcyc₆ - tewlw - tewнw) for write, (t_r + t_f) < (tcyc₆ - tewlr - tewнw) for read.

^{*2.} All timing is specified using 20% and 80% of VDD as the reference.

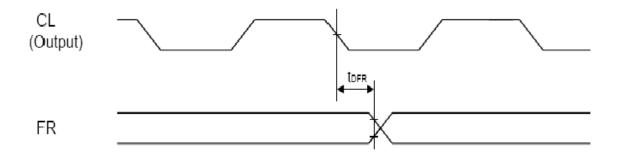
^{*3.} tewnw and tewnr are specified as the overlap interval when /CS1 is low (CS2 is high) and E is high.

Serial Interface Timing



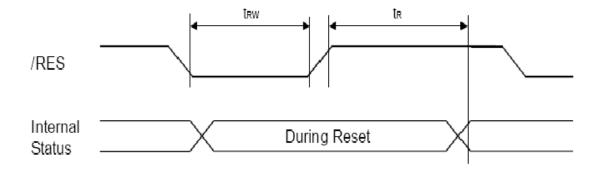
Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
tscyc	Serial clock cycle	120	-	-	ns	SCL
tsнw	Serial clock H pulse width	60	-	1	ns	SCL
ts∟w	Serial clock L pulse width	60	-	1	ns	SCL
tsas	Address setup time	30	-	-	ns	A0
tsah	Address hold time	20	1	1	ns	A0
tsps	Data setup time	30	-	1	ns	SI
tsрн	Data hold time	20	-	-	ns	SI
tcss	Chip select setup time	20	-	-	ns	/CS1, CS2
tсsн	Chip select hold time	40	-	-	ns	/CS1, CS2

Display Control Timing



Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
tofr	FR delay time	-	20	80	ns	CL = 50 pF

Reset Timing



Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
tr	Reset Time	-	-	1.0	μs	
trw	Reset low pulse width	10	-	-	μs	/RES

8. INSTRUCTION DESCRIPTION

G 1		/D.D.	/II.ID				T						
Command	A0	/RD	/WR	D7	D6	D5	D4	D3	D2	D1	D0	Hex	Function
(1)Display OFF	0	1	0	1	0	1	0	1	1	1	0 1	AEh AFh	Turn on LCD panel when high, and turn off when low
(2)Display start line set	0	1	0	0 1 Display start address								40h To 7Fh	Specifies RAM display line for com0
(3)Page address set	0	1	0	1	0	1	1	F	age a	ddres	SS	B0h To B8h	Set the display data RAM page in page address register
(4)Column address	0	1	0	0 0 0 1					Higher column address				Set 4 higher bits and 4 lower bits of column
set	0	1	0	0	0	0	0	Lower column address				To 18h	address of display data RAM in register
(5)Read status	0	0	1		Sta	tus		0	0 0 0 0				Read the status information
(6)Write display data	1	1	0	Write data								XX	Write data in display data RAM
(7)Read display data	1	0	1	Read data								XX	Read data from display data RAM
(8)ADC select	0	1	0	1	0	1	0	0	0	0	0	A0h A1h	Set the display data RAM address SEG output correspondence
(9)Normal/Reverse display	0	1	0	1	0	1	0	0	1	1	0 1	A6h A7h	Normal indication when low .but full indication when high
(10)Entire display on/off	0	1	0	1	0	1	0	0	1	0	0	A4h A5H	Select normal display (0) or entire display on
(11)LCD bias set	0	1	0	1	0	1	0	0	0	1	0	A2h A3h	Sets LCD driving voltage bias ratio
(12)Read –modify- write	0	1	0	1	1	1	0	0	0	0	0	E0h	Increments column address counter during each write
13) End	0	1	0	1	1	1	0	1	1	1	0	EEh	Releases the Read-Modify -Write
(14) Reset	0	1	0	1	1	1	0	0	0	1	0	E2h	Resets internal functions
(15) Common Output Mode Select	0	1	0	1	1	0	1	0	*	*	*	C0h to CFh	Select COM output scan direction invalid data
(16) Power Control Set	0	1	0	0	0	1	0	1	Operation Status			28h to 2Fh	Select the power circuit operation mode
17) V0 Voltage Regulator Internal Resistor ratio Set	0	1	0	0	0	1	0	0	Ratio			20h to 27h	Select internal resistor ratio Rb/Ra mode
(18) Electronic	0	1	0	1	0	0	0	0	0	0	1	81h	
Volume mode Set Electronic Volume Register Set	0	1	0	*	*	Electronic Control Value						XX	Sets the V0 output voltage electronic volume register
(19) Set Static indicator ON/OFF	0	1	0	1	0	1	0	1	1	0	0 1	ACh ADh	Sets static indicator ON/OFF 0: OFF, 1: ON

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Set Static Indicator Register	0	1	0	*	*	*	*	*	*	Mode		XX	Sets the flash mode
(20) Power Save	0	1	0	-	-	-	-	-	-	-	-	-	Compound command of Display OFF and Entire Display ON
(21) NOP	0	1	0	1	1	1	0	0	0	1	1	E3h	Command for non-operation
(22) Oscillation Frequency Select	0	1	0	1	1	1	0	0	1	0	0	E4h E5h	Select the oscillation frequency
(23) Partial Display mode Set	0	1	0	1	0	0	0	0	0	1	0	82h 83h	Enter/Release the partial display mode
(24) Partial Display Duty Set	0	1	0	0	0	1	1	0	Du	Duty Ratio		30h 37h	Sets the LCD duty ratio for partial display mode
(25) Partial Display Bias Set	0	1	0	0	0	1	1	1	Bi	Bias Ratio			Sets the LCD bias ratio for partial display mode
(26) Partial Start Line Set	0	1	0	1	1	0	1	0	0	1	1	D3h	Enter Partial Start Line Set
Partial Start Line Set	0	1	0	1	1	Partial Start Line						XX	Sets the LCD Number of partial display start line
(27) N-Line	0	1	0	1	0	0	0	0	1	0	1	85h	Enter N-Line inversion
Inversion Set Number of Line Set	0	0	*	*	*	*		Number of Line			;	XX	Sets the number of line used for N-Line inversion
(28) N-Line Inversion Release	0	1	0	1	0	0	0	0	1	0	0	84h	Exit N-Line Inversion
(29) DC/DC Clock Set	0	1	0	1	1	1	0	0	1	1	0	E6h	Set DC/DC Clock Frequency
DC/DC Clock Division Set	0	1	0	1	1	0	0					XX	Set the Division of DC/DC Clock Frequency
(30) Test Command	0	1	0	1	1	1	1	*	*	*	*	F1h to FFh	IC test command. Do not use!
(31) Test Mode Reset	0	1	0	1	1	1	1	0	0	0	0	F0h	Command of test mode reset

NOTE: Do not use any other command, or system malfunction may result

9. LCD MODULES HANDLING PRECAUTIONS

- The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- If the display panel is damaged and the liquid crystal substance inside it leaks out, do not get any in your mouth. If the substance come into contact with your skin or clothes promptly wash it off using soap and water.
- Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarize carefully.
- To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - -Be sure to ground the body when handling the LCD module.
 - -Tools required for assembly, such as soldering irons, must be properly grounded.
 - -To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions
 - -The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- Storage precautions

When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the modules in bags designed to prevent static electricity charging under low temperature / normal humidity conditions (avoid high temperature / high humidity and low temperatures below -20°C). Whenever possible, the LCD modules should be stored in the same conditions in which they were shipped from our company.

10. OTHERS

- Liquid crystals solidify at low temperature (below the storage temperature range) leading to defective orientation of liquid crystal or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subjected to a strong shock at a low temperature.
- If the LCD modules have been operating for a long time showing the same display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. Abnormal operating status can be resumed to be normal condition by suspending use for some time. It should be noted that this phenomena does not adversely affect performance reliability.
- To minimize the performance degradation of the LCD modules resulting from caused by static electricity, etc. exercise care to avoid holding the following sections when handling the modules:
 - Exposed area of the printed circuit board
 - Terminal electrode sections.